Terminal Pad Solderability: Meets EIA Specification RS186-9E And ANSI/J-STD-002 Category 3.

Terminal Pad Materials: Tin-plated Nickel-Copper

Lead-Free, RoHS Compliant

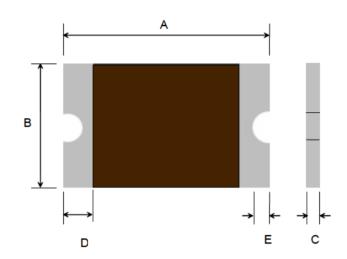


TABLE I. DIMENSIONS:

Model	Marking	Α		В		С		D	
		Min.	Max.	Min.	Max.	Min.	Max.	Min.	
BpS03-350-06	3	1.45	1.85	0.65	1.05	0.40	1.00	0.15	Unit:mm

TABLE II. PERFORMANCE RATING:

Model	Marking	V_{max}	I _{max}	I _{hold}	I _{trip}	P_d	Maximum Time To Trip		Resistance	
				@25°C	@25°C	Тур.	Current	Time	Ri _{min}	R1 _{max}
		(Vdc)	(A)	(A)	(A)	(W)	(A)	(Sec)	(Ω)	(Ω)
BpS03-350-06	3	6.0	40	0.35	0.75	0.50	8.0	0.10	0.200	1.400

Ihoid = Hold Current. Maximum current device will not trip in 25°C still air.

Itrip = Trip Current. Minimum current at which the device will always trip in 25°C still air.

Vmax = Maximum operating voltage device can withstand without damage at rated current (Imax).

Imax = Maximum fault current device can withstand without damage at rated voltage (Vmax).

Pd = Maximum power dissipation when device is in the tripped state in 25°C still air environment at rated voltage. Rimin/max = Minimum/Maximum device resistance prior to tripping at 25°C.

R1max = Maximum device resistance is measured one hour post reflow.

CAUTION: Operation beyond the specified ratings may result in damage and possible arcing and flame.